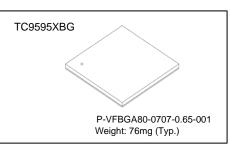
CMOS Digital Integrated Circuit Silicon Monolithic

TC9595XBG

Overview

TC9595XBG is a bridge device that enables video streaming from a Host (application or baseband processor) over MIPI[®] DSISM or DPISM link to drive DisplayPort[™] display panels. TC9595XBG also supports audio streaming from the host via I2S interface to the Display panels. TC9595XBG provides a low power bridge solution to efficiently translate MIPI[®] DSI or DPI transfers to DisplayPort[™] transfers. As the



DisplayPort[™] uses fewer wires compared to other existing display panel standards, it simplifies the LCD connectivity. The effect of using TC9595XBG is to enable existing baseband devices supporting DSI or DPI streaming to connect to new panels supporting DisplayPort[™] interface and also to connect to existing panels over longer distance using DisplayPort[™] adaptors at far-end.

Features

- Translates MIPI[®] DSI/DPI Link video stream from Host to DisplayPort[™] Link data to external display devices.
- The inputs are driven by a DSI Host with 4-Data Lanes, upto1 Gbps/lane or DPI Host with 16/18/24 bit interface upto154 MHz parallel clock.
- Embeds audio information from the I2S port into the DisplayPort[™] data stream.
- The output Interface consists of a DisplayPort[™] Tx with a 2-lane Main Link and AUX-Ch.
- Register Configuration: From DSI link or I²C interface.
- Interrupt to host to inform any error status or status needing attention from Host.
- Internal test pattern (color bar) generator for DP output testing without any video (DSI/DPI) input.
- Debug/Test Port: I²C Slave

DSI Receiver

- ♦ MIPI[®] DSI: v1.01 / MIPI[®] D-PHY: v0.90 Compliant.
- ♦ Up to four (4) Data Lanes with Bi-direction support on Data Lane 0.
- ♦ Maximum speed at 1 Gbps/lane.
- Supports Burst as well as Non-Burst Mode Video Data.
- Video data packets are limited to one row per HSYNC period.
- Supports video stream packets for video data transmission.

- Supports generic long packets for accessing the chip's register set.
- ♦ Video input data formats:
 - RGB-565, RGB-666 and RGB-888.
- New DSI V1.02 Data Type Support: 16-bit YCbCr 422
- ♦ Interlaced video mode is not supported.

DPI Receiver

- \diamond Up to 16 / 18 / 24 bit parallel data interface.
- ♦ Maximum speed at 154 MPs (Mpixel per sec).
- Video input data formats: RGB-565, RGB-666 and RGB-888.
- ♦ Only Progressive mode supported.
- **I2S Audio Interface:** Supports one I2S port for audio streaming from the host to TC9595XBG.
- Supports slave mode (BCLK, LRCLK & oversampling clock input from Host).
- ♦ Supports sampling frequencies of 32, 44.1, 48, 88.2, 96, 176.4 & 192 kHz.
- ♦ Supports up to 2 audio channels.
- ♦ Supports 16, 18, 20 or 24bits per sample.
- Optionally inserts IEC60958 status bits and preamble bits per channel.
- **DisplayPort[™] Interface:** Supports a DisplayPort[™] link from TC9595XBG to display panels.
- → High speed serial bridge chip using VESA[®] DisplayPort[™] 1.1a Standard.
- Support 1.62 or 2.7 Gbps/lane data rate with voltage swings @0.4, 0.6, 0.8 or 1.2 V Support of pre-emphasis levels of 0, 3.5 and 6dB.

- Supports Audio related Secondary Data Packets.
- ♦ AUX channel supported at 1 Mbps.
- ♦ HPD support through GPIO based interrupts
- Enhanced mode supported for content protection.
- ♦ Not support HDCP.
- Secure ASSR (Alternate Scrambler Seed Reset) support.
- Stream Policy Maker is assumed handled by the Host (software/firmware).
- Start Link training in response to HPD & read final Link training status
- Configure DP link for actual video streaming & start video streaming
- Link Policy maker is assumed shared between the Host and TC9595XBG chip.
- In auto_correction = 0 mode, control link training
- Initiate Display device capabilities read and configure TC9595XBG accordingly.
- Video timing generation as per panel requirement.
- SSCG with a 30 kHz modulation to reduce EMI.
- ♦ Built in PRBS7 Generator to test DisplayPort[™] Link.

RGB Parallel Output Interface:

- ♦ RGB888 output (DisplayPort[™] disabled) with only DSI input supported in this mode
- ♦ PCLK max. = 100 MHz
- Polarity control for PCLK, VSYNC, HSYNC & DE

• I²C Interface:

- I²C compliant slave interface support for normal (100 kHz) and fast mode (400 kHz).

• GPIO Interface:

- \diamond 2 bits of GPIO (shared with other digital logic).
- \diamond Direction controllable by Host I²C accesses.

Clock Source:

- ♦ DisplayPort[™] clock source is from an external clock input (13, 26, 19.2 or 38.4 MHz) or clock from DSI interface – generates all internal & output clocks to interfacing display devices.
- ♦ Built-in PLLs generate high-speed DisplayPort[™] link clock requiring no external components. These PLLs are part of the DisplayPort[™] PHY.
- Clock and power management support to achieve low power states.

• Possible modes of Operation:

- ♦ MODE S21: TC9595XBG uses DisplayPortTM Tx as single 2-lane DisplayPortTM link to interface to single DisplayPortTM display device. Video stream source is from MIPI[®] DSI Host.
- ♦ MODE P21: TC9595XBG uses DisplayPortTM Tx as single 2-lane DisplayPortTM link to interface to single DisplayPortTM display device. Video stream source is from MIPI[®] DPI Host.
- ♦ MODE S2P: TC9595XBG uses only Parallel output port and disables DisplayPort[™] Tx to interface to single RGB display device. Video stream source is from MIPI[®] DSI Host.

Power supply inputs

- ♦ Core and MIPI[®] D-PHY: 1.2 V ± 0.06 V
- ♦ Digital I/O: $1.8 \vee \pm 0.09 \vee$
- ♦ DisplayPortTM: $1.8 V \pm 0.09 V$
- ♦ DisplayPortTM: $1.2 V \pm 0.06 V$
- Power Consumptions (Typical value based on estimations)
- Power-down mode (DSI-Rx in ULPS, DP PHY & PLLs disabled, clocks stopped):
 - DSI Rx: 0.01 mW
- DP PHY: 2.34 mW
- PLL9: 0.01 mW
- Core: 0.96 mW
- Rest: 0.01 mW
- Normal operation (1920 × 1080 resolution with DSI-Rx in 4-lane @925 Mbps per lane, DP PHY in dual lane link @2.7 Gbps per lane):
- DSI Rx: 21.79 mW
- DP PHY: 142.70 mW
- PLL9: 2.42 mW
- Core: 87.64 mW
- IOs: 1.68 mW
- Package
 - 0.65mm ball pitch, 80 balls, 7 × 7 mm BGA package
- AEC-Q100 qualified with the following definition
 - Grade3: -40 °C to 85 °C ambient operating temperature range

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REFERENCES

- 1. MIPI® DSI, "MIPI® Alliance Specification for DSI Version 1.01.00 21 February 2008"
- MIPI[®] DPI, "MIPI Alliance Standard for Display Pixel Interface (DPI-2) Version 2.00 15 September 2005"
- 3. MIPI® D-PHY, "DRAFT MIPI® Alliance Specification for D-PHY Version 0.91.00 r0.01 14-March-2008"
- 4. VESA[®] DisplayPort[™] Standard (Version 1, Revision 1A January 11, 2008)
- 5. VESA[®] embedded DisplayPort[™] (eDP) Standard (Version 1.1 October 23, 2009)
- 6. I²C bus specification, version 2.1, January 2000, Philips Semiconductor
- Draft CEA-861-C, A DTV Profile for Uncompressed High Speed Digital Interfaces (Doc. Number: CEA-861rCv9.pdf (PNXXX)) Date: 05/04/2005
- 8. DisplayPort[™] PHY DFT Strategy Specification Rev 1.3

1. Overview

The DSI/DPI to DisplayPort[™] converter (TC9595XBG) is a bridge device that enables video streaming from a Host (application or baseband processor) over MIPI[®] DSI or DPI link to drive DisplayPort[™] display panels. TC9595XBG also supports audio streaming from the host via I2S interface to the Display panels. TC9595XBG provides a low power bridge solution to efficiently translate MIPI[®] DSI or DPI transfers to DisplayPort[™] transfers. As the DisplayPort[™] uses fewer wires compared to other existing display panel standards, it simplifies the LCD connectivity. The effect of using TC9595XBG is to enable existing baseband devices supporting DSI or DPI streaming to connect to new panels supporting DisplayPort[™] interface and also to connect to existing panels over longer distance using DisplayPort[™] adaptors at far-end.

The chip can be configured through the DSI link by sending write/read register commands through DSI Generic Long Write packets. It can also be configured through the I²C Slave interface.

The DSI-RX receiver supports from 1 to 4-Lane configurations at bit rate up to 1 Gbps per lane. Host can transmit video in continuous video streaming mode. Host controls video timing by sending video frame and line sync events together with video pixel data; video data transmission can be burst or non-burst. Since the chip integrates only a small video buffer, Host still has to take care of transmitting pixel data at appropriate video line time in order to avoid buffer overflow (or underflow).

The DPI-Rx receiver supports 16, 18 or 24 bits parallel interface along with the required control signals for the Pixel clock and HSYNC/VSYNC/DE.

The DisplayPort[™] transmitter supports data throughput at 1.62 Gbps or 2.7 Gbps per lane of main link. TC9595XBG supports three configuration modes. These modes mainly differ based on the source of input stream and output interface.

- Mode_S21: A system configuration where TC9595XBG may typically be used is shown in Figure 1.1. In this configuration, the TC9595XBG can support displays with resolution up to WUXGA (1920×1200) at 24bit, 60 fps or WUXGA (1920×1200) at 18bit, 60 fps. Video stream source is from DSI Host.
- Mode_P21: A system configuration where TC9595XBG may typically be used is shown in Figure 1.2. This is similar to the Mode_S21 except that the video stream source is from DPI Host. In this configuration, the TC9595XBG can support displays with resolution up to WUXGA (1920×1200) at 24bit, 60 fps.
- Mode_S2P: A system configuration where TC9595XBG may typically be used is shown in Figure 1.3. In this mode, DisplayPort[™] output is not used and the chip rather behaves as a DSI to RGB convertor. In this system, TC9595XBG could be connected to a single display. In this configuration, the TC9595XBG can support displays with resolution up to WXGA (1280x800 or 1366x768). Maximum output PCLK is 100MHz. Video stream source is from DSI Host.

The chip supports power management to conserve power when its functions are not in use. Host manages the chip's power consumption modes by using ULPS messages over DSI link during DPI input mode.

The following figures show all these modes, where TC9595XBG, display panels and a Host are connected in target Reference system for mobile large display panel applications.

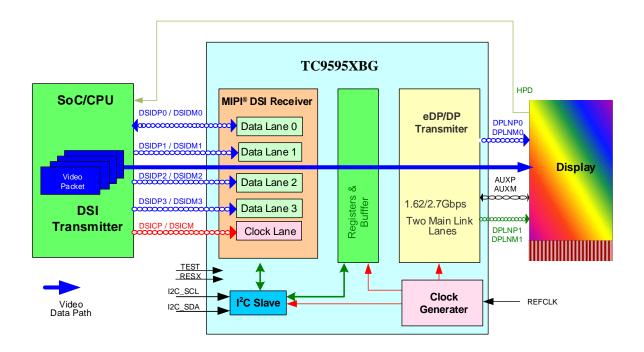


Figure 1.1 System Overview with TC9595XBG in MODE_S21 Configuration

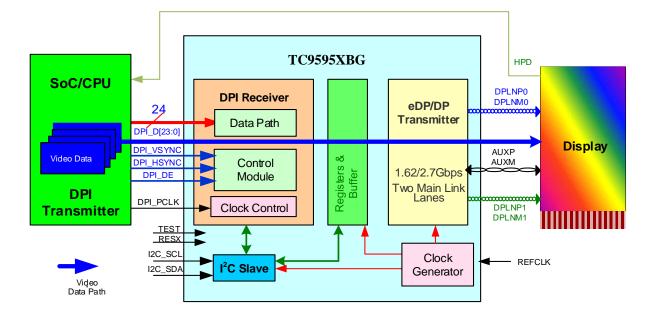


Figure 1.2 System Overview with TC9595XBG in MODE_P21 Configuration

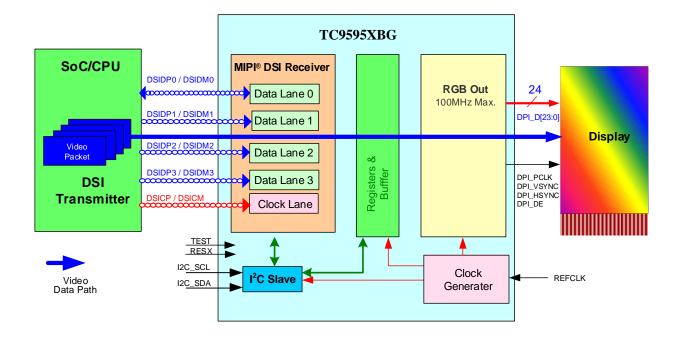


Figure 1.3 System Overview with TC9595XBG in MODE_S2P Configuration

2. Features

Below are the main features supported by TC9595XBG.

- Translates MIPI[®] DSI/DPI Link video stream from Host to DisplayPort[™] Link data to external display devices.
- The inputs are driven by a DSI Host with 4-Data Lanes, upto1 Gbps/lane or DPI Host with 16/18/24 bit interface upto154 MHz parallel clock.
- Embeds audio information from the I2S port into the DisplayPortTM data stream.
- The output Interface consists of a DisplayPort[™] Tx with a 2-lane Main Link and AUX-Ch.
- Register Configuration: From DSI link or I²C interface.
- Interrupt to host to inform any error status or status needing attention from Host.
- Internal test pattern (color bar) generator for DP output testing without any video (DSI/DPI) input.
- Debug/Test Port: I²C Slave
- DSI Receiver
 - ♦ MIPI[®] DSI: v1.01 / MIPI[®] D-PHY: v0.90 Compliant.
 - \diamond Up to four (4) Data Lanes with Bi-direction support on Data Lane 0.
 - ♦ Maximum speed at 1 Gbps/lane.
 - ♦ Supports Burst as well as Non-Burst Mode Video Data.
 - Video data packets are limited to one row per HSYNC period.
 - ♦ Supports video stream packets for video data transmission.
 - ♦ Supports generic long packets for accessing the chip's register set.
 - ♦ Video input data formats:
 - RGB-565, RGB-666 and RGB-888.
 - New DSI V1.02 Data Type Support: 16-bit YCbCr 422
 - ♦ Interlaced video mode is not supported.

• DPI Receiver

- \diamond Up to 16 / 18 / 24 bit parallel data interface.
- ♦ Maximum speed at 154 MPs (MPixel per sec).
- ♦ Video input data formats: RGB-565, RGB-666 and RGB-888.
- ♦ Only Progressive mode supported.
- I2S Audio Interface: Supports one I2S port for audio streaming from the host to TC9595XBG.
 - ♦ Supports slave mode (BCLK, LRCLK & over-sampling clock input from Host).
 - ♦ Supports sampling frequencies of 32, 44.1, 48, 88.2, 96, 176.4 & 192 kHz.
 - ♦ Supports up to 2 audio channels.
 - ♦ Supports 16, 18, 20 or 24 bits per sample.
 - ♦ Optionally inserts IEC60958 status bits and preamble bits per channel.
- **DisplayPort[™] Interface:** Supports a DisplayPort[™] link from TC9595XBG to display panels.
 - ♦ High speed serial bridge chip using VESA[®] DisplayPort[™] 1.1a Standard.
 - ♦ Supports one dual-lane DisplayPort[™] port for high bandwidth applications.
 - ♦ Support 1.62 or 2.7 Gbps/lane data rate with voltage swings @0.4, 0.6, 0.8 or 1.2 V.
 - ♦ Support of pre-emphasis levels of 0, 3.5 and 6 dB.
 - ♦ Supports Audio related Secondary Data Packets.
 - ♦ AUX channel supported at 1 Mbps.
 - ♦ HPD support through GPIO based interrupts
 - ♦ Enhanced mode supported for content protection.
 - ♦ Not support HDCP.
 - ♦ Secure ASSR (Alternate Scrambler Seed Reset) support for embedded DisplayPort[™] panels
 - ♦ Stream Policy Maker is assumed to be handled by the Host (software/firmware).
 - Start Link training in response to HPD & read final Link training status
 - Configure DP link for actual video streaming & start video streaming
 - \diamond Link Policy maker is assumed shared between the Host and TC9595XBG chip.
 - In auto_correction = 0 mode, control link training
 - Initiate Display device capabilities read and configure TC9595XBG accordingly.

- ♦ Video timing generation as per panel requirement.
- ♦ SSCG with a 30 kHz modulation to reduce EMI.
- ♦ Built in PRBS7 Generator to test DisplayPort[™] Link.

• RGB Parallel Output Interface:

- ♦ RGB888 output (DisplayPort[™] disabled) with only DSI input supported in this mode
- ♦ PCLK max. = 100 MHz
- ♦ Polarity control for PCLK, VSYNC, HSYNC & DE

• I²C Interface:

- \Rightarrow I²C slave interface for chip register set access enabled using a boot-strap option.

• GPIO Interface:

- \diamond 2 bits of GPIO (shared with other digital logic).
- \diamond Direction controllable by Host I²C accesses.

Clock Source:

- ♦ DisplayPort[™] clock source is from an external clock input (13, 26, 19.2 or 38.4 MHz) or clock from DSI interface – generates all internal & output clocks to interfacing display devices.
- ♦ Built-in PLLs generate high-speed DisplayPortTM link clock requiring no external components. These PLLs are part of the DisplayPortTM PHY.
- Clock and power management support to achieve low power states.

• Possible modes of Operation:

- ♦ MODE S21: TC9595XBG uses DisplayPort[™] Tx as single 2-lane DisplayPort[™] link to interface to single DisplayPort[™] display device. Video stream source is from MIPI[®] DSI Host.
- ♦ MODE P21: TC9595XBG uses DisplayPortTM Tx as single 2-lane DisplayPortTM link to interface to single DisplayPortTM display device. Video stream source is from MIPI[®] DPI Host.
- ♦ MODE S2P: TC9595XBG uses only Parallel output port and disables DisplayPort[™] Tx to interface to single RGB display device. Video stream source is from MIPI[®] DSI Host.

• Power supply inputs

- \diamond Core and MIPI[®] D-PHY: 1.2 V ± 0.06 V
- ♦ Digital I/O: $1.8 V \pm 0.09 V$
- ♦ DisplayPort[™]: 1.8 V ± 0.09 V
- ♦ DisplayPortTM: $1.2 V \pm 0.06 V$

• Power Consumptions (Typical value based on estimations)

- ♦ Power-down mode (DSI-Rx in ULPS, DP PHY & PLLs disabled, clocks stopped):
 - DSI Rx: 0.01 mW
 - DP PHY: 2.34 mW
 - PLL9: 0.01 mW
 - Core: 0.96 mW
 - Rest: 0.01 mW
- Normal operation (1920×1080 resolution with DSI-Rx in 4-lane @925 Mbps per lane, DP PHY in dual lane link @2.7 Gbps per lane):
 - DSI Rx: 21.79 mW
 - DP PHY: 142.70 mW
 - PLL9: 2.42 mW
 - Core: 87.64 mW
 - IOs: 1.68 mW
- Package
 - 0.65mm ball pitch, 80 balls, 7 × 7 mm BGA package

AEC-Q100 Qualified with the following definition

- Grade3: -40°C to 85°C ambient operating temperature range

Mada	Input Confi	guration	Register Access	Max Panel
Mode	DSI input	DPI input	Method	size example
S21	Active	-	DSI or I ² C	WUXGA 18bpp @ 60fps WUXGA 24bpp @ 60fps
P21	-	Active	l ² C	WUXGA 24bpp @ 60fps

Table 2.1	TC9595XBG operational modes summary with panel size support information
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Tables below provide an idea of different panel sizes that can be supported by using different data link lane configurations.

 Table 2.2
 Panel Size v/s Data link required by TC9595XBG in DSI input case

				RGB6	66			RGB	888			
		With Overhead	FPS	Pixel Clock (MHz)	Bit Rate (Gbps)	# DSI Data	# DP linl		Bit Rate (Gbps)	# DSI Data	# DP Ma	in links
		overnedd		· · /	(0000)	lanes	1.62G	2.7G	(0500)	lanes	1.62G	2.7G
XGA	1024×768	1184×790	60	56	1.01	2	1	1	1.34	2	2	1
WXGA+ / WSXGA	1440×900	1600×926	60	89	1.60	2	2	1	2.13	3	2	1
SXGA+	1400×1050	1560×1080	60	89	1.82	2	2	1	2.43	3	2	2
WSXGA+	1680×1050	1840×1080	60	119	2.15	3	2	1	2.86	3	-	2
UXGA	1600×1200	1760×1235	60	130	2.35	3	2	2	3.13	4	-	2
WUXGA	1920×1200	2080×1235	60	154	2.77	3	-	2	3.70	4	-	2

Table 2.3	3 Panel Size v/s Data link required by TC9	595XBG in DPI input case
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Frame Size							GB666		R	GB888	
		With Overhead	FPS	Pixel Clock (MHz)	DPI Support 154 MHz PCLK	Bit Rate (Gbps)	# DP lin		Bit Rate (Gbps)		Main Iks
		Overneau		(I OLIX	(Gobs)	1.62G	2.7G	(Gops)	1.62G	2.7G
XGA	1024×768	1184×790	60	56	Yes	1.01	1	1	1.34	2	1
WXGA+ / WSXGA	1440×900	1600×926	60	89	Yes	1.60	2	1	2.13	2	1
SXGA+	1400×1050	1560×1080	60	89	Yes	1.82	2	1	2.43	2	2
WSXGA+	1680×1050	1840×1080	60	119	Yes	2.15	2	1	2.86	-	2
UXGA	1600×1200	1760×1235	60	130	Yes	2.35	2	2	3.13	-	2
WUXGA	1920×1200	2080×1235	60	154	Yes	2.77	-	2	3.70	-	2

Note: These are the formats commonly used by displays. Support for other sizes is possible as long as they satisfy the maximum data rate constraints on the DSI and DisplayPort[™] link interfaces.

Note: Throughout the rest of the document, "DP" is used to denote "DisplayPort[™]". Both these words have been used interchangeably and refer to the VESA[®] DisplayPort[™] specification as mentioned in the references.

3. External Pins

3.1. TC9595XBG External Pins

TC9595XBG uses an 80ball package. Following table gives the signals of TC9595XBG and their function.

Group	Pin Name	I/O	Туре	Function	Note
	RESX	I	Sch	System Reset – active Low 0: Reset 1: Normal operation	_
	REFCLK	I	Sch	13, 26, 19.2 or 38.4 MHz 50ps phase jitter p2p/ WC duty cycle 40-60%	—
	INT	0	N	Interrupt to Host – active High 0: No interrupt is generated 1: Interrupt is generated	4mA
System:	DISABLE_ASSR	I	N	ASSR control 0: Enable ASSR 1: Disable ASSR	_
Reset, Clock, Mode select, Test (9)	MODE[1:0]	I	Ν	Mode Selection pins MODE_0: 0: REFCLK is source of internal DP PLL 1: When REFCLK="0", DSI clock is source of internal DP PLL. When REFCLK="1", DPI PCLK is source of internal DP PLL. MODE_1: When MODE_0="1" & REFCLK="0" this pin will be effective. 0: DSI clock/2/7 is source of internal DP PLL. 1: DSI clock/2/9 is source of internal DP PLL.	_
	TEST	I	N	Test Pin - active high 0: Normal operation 1: Test mode	_
	TEST3	0	N	Test Pin, Open	_
	VPGM0	NA	_	eFUSE programming voltage. Connect to GND	—
	DSICP	I	MIPI [®] -PHY	MIPI [®] -DSI Rx Clock Lane Pos.	_
	DSICM	I	MIPI [®] -PHY	MIPI [®] -DSI Rx Clock Lane Neg.	_
DSI Rx	DSIDP0	I/O	MIPI [®] -PHY	MIPI [®] -DSI Rx Data Lane Pos.	_
(10)	DSIDM0	I/O	MIPI [®] -PHY	MIPI [®] -DSI Rx Data Lane Neg.	—
	DSIDP[3:1]	I	MIPI [®] -PHY	MIPI [®] -DSI Rx Data Lane Pos.	_
	DSIDM[3:1]	I	MIPI [®] -PHY	MIPI [®] -DSI Rx Data Lane Neg.	—
	DPLNP[1:0]	0	DP-PHY	embedded DisplayPort [™] Output Main Link Pos.	—
	DPLNM[1:0]	0	DP-PHY	embedded DisplayPort [™] Output Main Link Neg.	—
DP Out (8)	DPAUXP	I/O	DP-PHY	embedded DisplayPort [™] Output AUX Channel Pos	
	DPAUXM	I/O	DP-PHY	embedded DisplayPort [™] Output AUX Channel Neg	
	PREC_RES[1:0]	I	DP-PHY	Precision Resistance (3k Ω @ 1%) connection	-
	DPI_PCLK	I/O	N	DPI Pixel Clock (max 154 MHz) (default: Input)	4mA
DPI Tx/Rx	DPI_VSYNC	I/O	N	DPI Vertical Sync (default: Input)	4mA
(28)	DPI_HSYNC	I/O	N	DPI Horizontal Sync (default: Input)	4mA
()	DPI_DE	I/O	N	DPI Data Enable (default: Input)	4mA
	DPI_D [23:0]	I/O	N	DPI Parallel Data (default: Input)	4mA
I ² C	I2C_SCL	OD	Sch	I ² C Clock	<u> </u>
(3)	I2C_SDA	OD	Sch	I ² C Data	4mA

 Table 3.1
 TC9595XBG Functional Signal List for 80-ball Package

			1		
	I2C_ADR_SEL	I	N	I ² C Slave Address Select 0: Slave address=7'b1101_000 1: Slave address=7'b0001_111	_
	SD/I2S_OSCLK		N	I2S Over Sampling Clock	—
12S	I2S_BCLK		N	I2S Bit Clock (max 12.5 MHz)	
(4)	I2S_LRCLK		N	I2S sample clock (max 192 kHz)	_
	I2S_DATA	I	N	I2S Data	—
GPIO (2)	GPIO[1:0]	OD	5T-OD	GPIO or Test Control ^{*Note1} GPIO[1:0] can be used for HPD support	4mA
	VDDC (1.2V)	NA	—	VDD for Internal Core (2)	—
	VDDS (1.8V)	NA	—	VDDS for IO Ring power supply (1)	_
	VDD_PLL18 (1.8V)	NA		VDD for DP PHY PLLs (1)	_
POWER (10)	VDD_DP18 (1.8V)	NA	—	VDD for DP PHY Main Channels (2)	
(10)	VDD_PLL912 (1.2V)	NA	—	VDD for PLL9 (1)	—
	VDD_DP12 (1.2V)	NA	—	VDD for DP PHY (2)	—
	VDD_DSI12 (1.2V)	NA	_	VDD for the MIPI [®] DSI PHY (1)	_
GROUND	VSS	NA		Ground (Core, DSI, I/O) (3)	
(6)	VSS_DP	NA	_	Ground (DP) (3)	_

Note 1: Pins with multiplexed Functional mode functions.

PHY:	Either DP analog front end or MIPI® D-PHY
------	---

Sch: Schmitt trigger input

OD: Open drain

5T-OD: 5 V tolerant bi-direction buffer with Open drain

3.2. TC9595XBG Ball Mapping

The mapping of TC9595XBG signals to the external pins is given in the following figure. (BGA array)

	1	2	3	4	5	6	7	8	9	10
۷	INT	GPIO0	DPI_VSYNC	DPI_D0	VDDC	VDDC	DPI_D3	VDDS	I2C_SDA	I2C_SCL
£	DSIDM0	DSIDP0	DPI_DE	DPI_HSYNC	DPI_D1	DPI_D2	DPI_D4	DPI_D7	DPI_D5	DPI_D6
υ	DSIDM1	DSIDP1							DPI_D9	DPI_D8
۵	DSICM	DSICP		I2S_LRCLK	I2S_BCLK	SD/ I2S_OSCLK	I2S_DATA		DPI_D13	DPI_D14
ш	VDD_DSI12	I2C_ADR_SEL		VSS	TEST3	VPGM0	DPI_D10		DPI_D16	DPI_D15
L.	DSIDM2	DSIDP2		VSS	VSS	TEST	DPI_D11		DPI_D17	DPI_D18
U	DSIDM3	DSIDP3		VSS_DP	VSS_DP	VSS_DP	DPI_D12		DPI_D19	DPI_PCLK
Ŧ	PREC_RES0	DISABLE_ASSR							DPI_D20	DPI_D21
-	PREC_RES1	MODE1	DPLNP0	VDD_DP12	MODE0	DPLNP1	GPIO1	DPAUXP	RESX	DPI_D23
×	REFCLK	VDD_DP18	DPLNM0	VDD_DP12	VDD_PLL18	DPLNM1	VDD_DP18	DPAUXM	VDD_PLL912	DPI_D22

Top View

Figure 3.1 TC9595XBG 80-ball Layout

4. Package

The package for TC9595XBG is described in the figure below.

Unit: mm

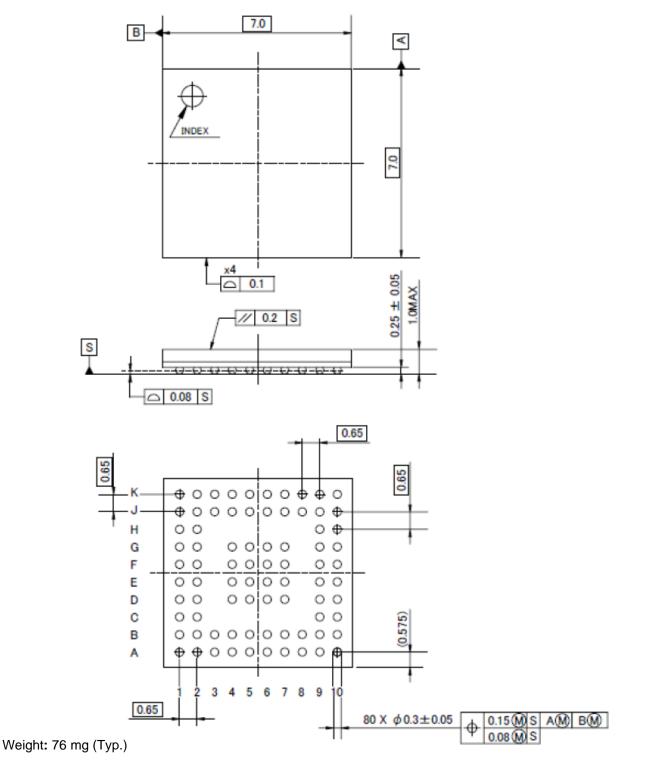


Figure 4.1 80 ball TC9595XBG package

5. Electrical Characteristics

5.1. Absolute Maximum Ratings

VSS/VSS_DP= 0 V reference

Parameter	Symbol	Rating	Unit		
Supply voltage (VDD_PLL18, VDD_DP18)	VDD18	-0.3 to +3.5	V		
Supply voltage (VDDC, VDD_PLL12, VDD_PLL912, VDD_DP12, VDD_DSI12)	VDD12	-0.3 to +2.0	V		
Supply voltage (VDDS)	VDD18S	-0.3 to +3.5	V		
Input voltage	V _{IN}	-0.3 to VDDS+0.3	V		
Output voltage	V _{OUT}	-0.3 to VDDS+0.3	V		
Storage temperature	T _{stg}	-40 to +125	°C		

Table 5.1 Absolute Maximum Ratings

5.2. Operating Condition

VSS/VSS_DP = 0 V reference

Parameter	Symbol	Min	Тур.	Max	Unit
Supply voltage (VDD_PLL18, VDD_DP18)	VDD18	1.71	1.8	1.89	V
Supply voltage (VDDC, VDD_PLL12, VDD_PLL912, VDD_DP12, VDD_DSI12)	VDD12	1.14	1.2	1.26	V
Supply voltage (VDDS)	VDD18S	1.71	1.8	1.89	V
Operating frequency (internal)	F _{opr}	_	_	200	MHz
Operating temperature	Ta	-40	_	+85	°C

Table 5.2 Operating Condition

5.3. DC Electrical Specification

VSS/VSS_DP = 0V reference

Parameter	Symbol	Min	Тур.	Max	Unit
Input voltage High level CMOS input ^{Note1}	V _{IH}	0.7 VDDS	_	VDDS	V
Input voltage Low level CMOS input ^{Note1}	V _{IL}	0	_	0.3 VDDS	V
Input voltage High level CMOS Schmitt Trigger Note1	V _{IHS}	0.7 VDDS	—	VDDS	V
Input voltage Low level CMOS Schmitt Trigger ^{Note1}	V _{ILS}	0	—	0.3 VDDS	V
Output voltage High level	V _{OH}	0.8 VDDS	_	VDDS	V
Output voltage Low level Note1, Note2	V _{OL}	0	_	0.2 VDDS	V
Input leak current High level	I _{IH1} ^(Note3)	-10	_	10	μA
Input leak current Low level	I _{IL1} (Note4)	-10	_	10	μA
Input leak current Low level	I _{IL2} (Note5)	-200		-10	μA

Table 5.3 DC Electrical Specification

Note1: VDD18S within operating condition.

Note2: Output current value is according to each IO buffer specification. Output voltage changes with output current value.

Note3: Normal pin, or Pull-up I/O pin applied VDD18S supply voltage to input pin

Note4: Normal pin applied VSS (0 V) to input pin

Note5: Pull-up I/O pin applied VSS (0 V) to input pin

5.4. Power Consumption (Typical value based on estimation)

Typical power consumption as measured for the power-down modes and for normal operation are provided below:

- Power-down mode (DSI-Rx in ULPS, DP PHY & PLLs disabled, clocks stopped):
 - ♦ DSI Rx: 0.01 mW
 - ♦ DP PHY: 2.34 mW
 - ♦ PLL9: 0.01 mW
 - ♦ Core: 0.96 mW
 - ♦ Rest: 0.01 mW
- Normal operation (1920×1080 resolution with DSI-Rx in 4-lane @925 Mbps per lane, DP PHY in dual lane link @2.7 Gbps per lane):
 - ♦ DSI Rx: 21.79 mW
 - ♦ DP PHY: 142.70 mW
 - ♦ PLL9: 2.42 mW
 - ♦ Core: 87.64 mW
 - ♦ IOs: 1.68 mW

6. Revision History

Revision Date		Description			
0.1	2020-05-19	Newly released			
1.1	2021-06-23	Add "AEC-Q100 Qualified" to Features Modified Table 5.1 and Table 5.2			
1.2	2022-08-23	Corrected Typos in Features			
1.3	2023-07-31	Removed supporting HDCP			

Table 6.1 Revision History

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